

NPN Silicon RF Transistor
Preliminary data

- For highest gain low noise amplifier at 1.8 GHz

Outstanding $G_{ms} = 21$ dB

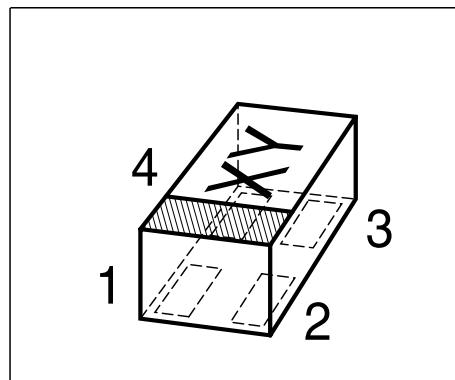
Noise Figure $F = 0.9$ dB

- Gold metallization for high reliability

- **SIEGET® 45** GHz fT- Line

- **Chip Scale Package**

typical dimension: 1.0 x 0.6 x 0.5mm



ESD: Electrostatic discharge sensitive device, observe handling precaution!

Type	Marking	Pin Configuration				Package
BFP 540ECSP	ATs	1 = B	2 = E	3 = C	4 = E	E-CSP

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	4.5	V
Collector-base voltage	V_{CBO}	14	
Emitter-base voltage	V_{EBO}	1	
Collector current	I_C	80	mA
Base current	I_B	4	
Total power dissipation, $T_S = \text{tbd } ^\circ\text{C}^1)$	P_{tot}	tbd	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Ambient temperature	T_A	-65 ... 150	
Storage temperature	T_{stg}	-65 ... 150	

Thermal Resistance

Junction - soldering point	R_{thJS}	$\leq \text{tbd}$	K/W
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¹ T_S is measured on the emitter lead at the soldering point to the pcb

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC characteristics					
Collector-emitter breakdown voltage $I_C = 1\text{ mA}, I_B = 0$	$V_{(BR)CEO}$	4.5	5	6.5	V
Collector-base cutoff current $V_{CB} = 5\text{ V}, I_E = 0$	I_{CBO}	-	-	200	nA
Emitter-base cutoff current $V_{EB} = 1\text{ V}, I_C = 0$	I_{EBO}	-	-	70	μA
DC current gain $I_C = 20\text{ mA}, V_{CE} = 3.5\text{ V}$	h_{FE}	50	110	200	-
AC Characteristics (verified by random sampling)					
Transition frequency $I_C = 50\text{ mA}, V_{CE} = 4\text{ V}, f = 1\text{ GHz}$	f_T	-	29	-	GHz
Collector-base capacitance $V_{CB} = 2\text{ V}, f = 1\text{ MHz}$	C_{cb}	-	tbd	-	pF
Collector-emitter capacitance $V_{CE} = 2\text{ V}, f = 1\text{ MHz}$	C_{ce}	-	tbd	-	
Emitter-base capacitance $V_{EB} = 0.5\text{ V}, f = 1\text{ MHz}$	C_{eb}	-	tbd	-	
Noise figure $I_C = 5\text{ mA}, V_{CE} = 2\text{ V}, Z_S = Z_{Sopt}, f = 1.8\text{ GHz}$	F	-	0.9	-	dB
Power gain, maximum stable ¹⁾ $I_C = 20\text{ mA}, V_{CE} = 2\text{ V}, Z_S = Z_{Sopt}, Z_L = Z_{Lopt}, f = 1.8\text{ GHz}$	G_{ms}	-	21	-	
Insertion power gain $I_C = 20\text{ mA}, V_{CE} = 2\text{ V}, f = 1.8\text{ GHz}, Z_S = Z_L = 50\Omega$	$ S_{21} ^2$	-	18.5	-	
Third order intercept point at output $V_{CE} = 2\text{ V}, f = 1.8\text{ GHz}, Z_S = Z_{Sopt}, Z_L = Z_{Lopt}, I_C = 20\text{ mA}$ $I_C = 7\text{ mA}$	IP_3	- -	24 20	- -	dBm
1dB compression point $V_{CE} = 2\text{ V}, f = 1.8\text{ GHz}, Z_S = Z_{Sopt}, Z_L = Z_{Lopt}, I_C = 20\text{ mA}$ $I_C = 7\text{ mA}$	P_{-1dB}	- -	12 4	- -	

$$^1G_{ms} = |S_{21} / S_{12}|$$